



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	Rds(on)	I _D T _A = +25°C
30V	5Ω @ V _{GS} = 4V	200mA
307	7Ω @ V _{GS} = 2.5V	115mA

Description

This new generation MOSFET has been designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.

Features

- N-Channel MOSFET
- Low On-Resistance
- Low Input Capacitance
- · Fast Switching Speed
- Small Surface Mount Package
- ESD Protected Gate 2kV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Qsuffix) part. A listing can be found at https://www.diodes.com/products/automotive/automotive-products/.
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
 https://www.diodes.com/quality/product-definitions/
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMN33D8LTQ</u>)

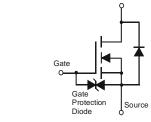
Mechanical Data

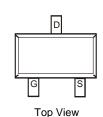
- Case: SOT523
- Case Material: Molded Plastic. "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed Over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 @3
- Terminal Connections: See Diagram
- Weight: 0.002 grams (Approximate)





Top View





Equivalent Circuit

Ordering Information (Note 4)

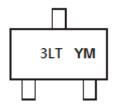
Part Number	Case	Packaging
DMN33D8LT-7	SOT523	3,000/Tape & Reel
DMN33D8LT-13	SOT523	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



3LT = Product Type Marking Code YM = Date Code Marking Y = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Key

Year	2014		2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	В			J	K	L	М	N	0	Р	R	S
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V_{DSS}	30	V
Gain-Source Voltage		Vgss	±20	V
Drain Current (Note 5)	Continuous	I _D	115	mA

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	240	mW
Thermal Resistance, Junction to Ambient (Note 5)	RθJA	521	°C/W
Total Power Dissipation (Note 6)	PD	300	mW
Thermal Resistance, Junction to Ambient (Note 6)	RθJA	420	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

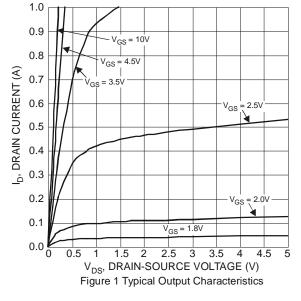


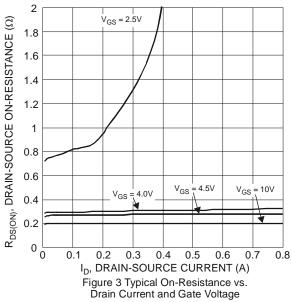
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

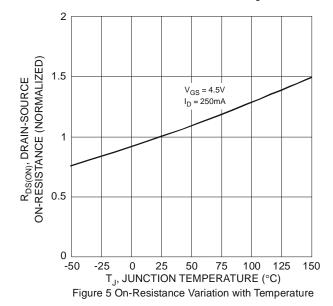
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	30		_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}			1.0	μΑ	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Body Leakage	Igss	_	_	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	0.8		1.5	>	$V_{DS} = 3V$, $I_{D} = 100 \mu A$	
Static Drain-Source On-Resistance	Dagger			5	Ω	$V_{GS} = 4V$, $I_D = 10mA$	
Static Dialii-Source Off-Resistance	Rds(on)	_	_	7	Ω	$V_{GS} = 2.5V, I_{D} = 5mA$	
Diode Forward Voltage	VsD	_	_	1.2	V	V _G S = 0V, I _S = 115mA	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	48	_			
Output Capacitance	Coss	_	11	_	pF	V _{DS} = 5V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	8	_			
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	0.55	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	1.23	_	nC	\/ 40\/ I- 050m A	
Gate-Source Charge	Q_{gs}	_	0.14	_	nc	$V_{DS} = 10V, I_{D} = 250mA$	
Gate-Drain Charge	Q_{gd}	_	0.14	_			
Turn-On Delay Time	td(ON)	_	2.9	_			
Turn-On Rise Time	t _R	—	2.6	—		V _{DD} = 30V, I _D = 0.2A, V _{GEN} = 10V,	
Turn-Off Delay Time	t _{D(OFF)}	_	18.2	—	ns	$R_{GEN} = 25\Omega$	
Turn-Off Fall Time	tF		13.6	_			

7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing. Notes:

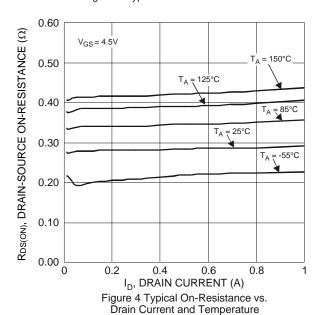


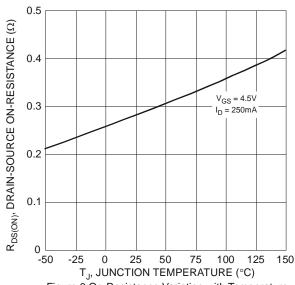






 $\begin{array}{c} 1 \\ 0.8 \\ \hline \\ 0.8 \\ \hline \\ 0.6 \\ \hline \\ 0.2 \\ \hline \\ 0.2 \\ \hline \\ 0.2 \\ \hline \\ T_A = 150^{\circ}\text{C} \\ \hline \\ T_A = 150^{\circ}\text{C} \\ \hline \\ T_A = 25^{\circ}\text{C} \\ \hline \\ T_A = 25^{\circ}\text{C} \\ \hline \\ V_{GS}, \text{ GATE-SOURCE VOLTAGE (V)} \\ \hline \\ \text{Figure 2 Typical Transfer Characteristics} \end{array}$







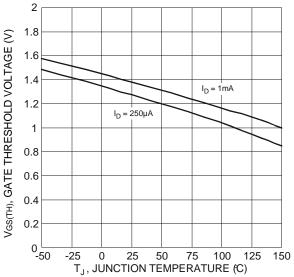
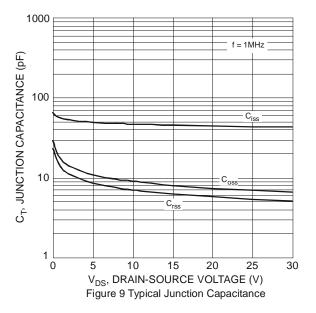
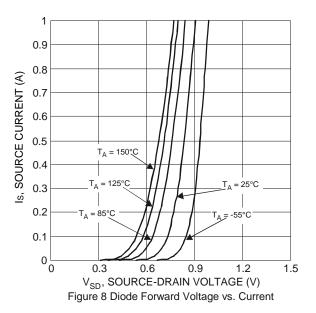
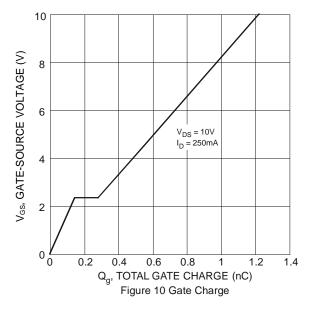


Figure 7 Gate Threshold Variation vs. Junction Temperature





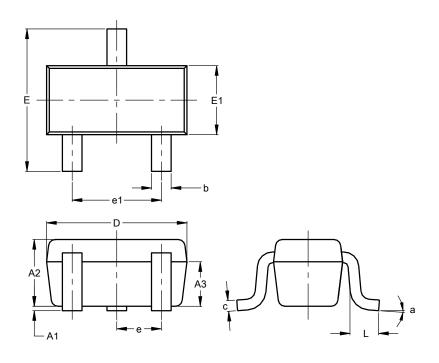




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT523

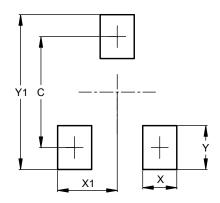


SOT523						
Dim	Min Max Typ					
A1	0.00	0.10	0.05			
A2	0.60	0.80	0.75			
A3	0.45	0.65	0.50			
b	0.15	0.30	0.22			
С	0.10	0.20	0.12			
D	1.50	1.70	1.60			
E	1.45	1.75	1.60			
E1	0.75	0.85	0.80			
е	e 0.50 BSC					
e1	0.90	1.10	1.00			
L	0.20	0.40	0.33			
а	0°		8°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT523



Dimensions	Value (in mm)		
С	1.29		
Х	0.40		
X1	0.70		
Υ	0.51		
Y1	1.80		



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